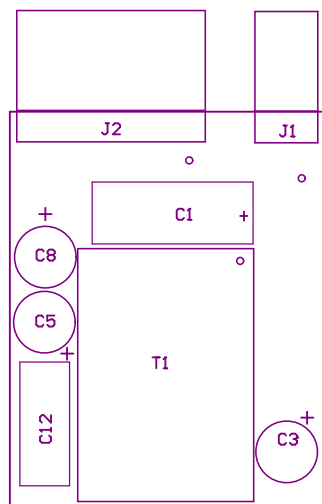


Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

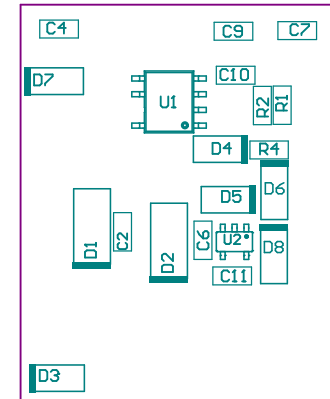
Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00708	REV: E1	SUN REV: Not In VersionControl
M5 Assembly Top	TID #: TIDA-00708		
PLOT NAME = Top LayerAssembly Drawing	GENERATED : 3/17/2016 3:00:40 PM	TEXAS INSTRUMENTS	

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: [No Variations]



PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00708	REV: E1	SUN REV: Not In VersionControl
M6 Assembly Bottom	TID #: TIDA-00708		
PLOT NAME = Bottom LayerAssembly Drawing	GENERATED : 3/17/2016	3:00:40 PM	TEXAS INSTRUMENTS

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